

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

## **SAW** components

BAW filter

WLAN 2G; Bluetooth

Series/type: B4346 Ordering code: B39242B4346P810

Date: Version: April 13, 2016 2.0

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# ⊗TDK

SAW components	B4346
BAW filter	2442 MHz

Data sheet

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#### **BAW** filter

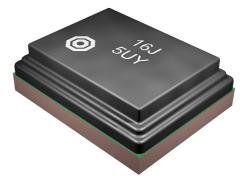
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### 1 Application

- Low-loss BAW RF single filter for Bluetooth/WLAN with LTE Band 7 / Band 40 / Band 41 coexistence for Automotive telematics
- Usable pass band 79.0 MHz
- Excellent insertion loss
- High out of band selectivity
- Filter impedance 50 Ω
- Excellent B7 attenuation

### 2 Features

- Package size 1.4±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Package code QCU5D
- Approximate weight 2 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- AEC-Q200 qualified component family (operable temperature range -40 °C to +85 °C)
- Electrostatic Sensitive Device (ESD)



**Figure 1:** Picture of component with example of product marking.

### B4346



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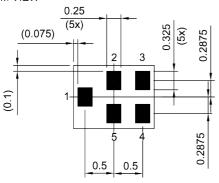
### SAW components

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### 3 Package

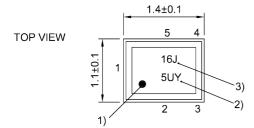
BOTTOM VIEW



Pad and pitch tolerance ±0.05

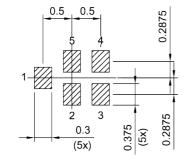
SIDE VIEW

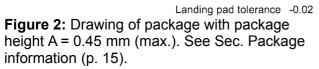




- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



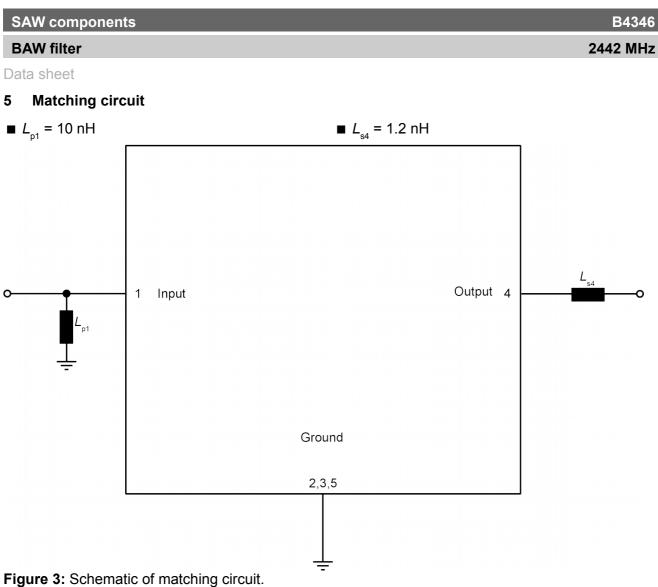




### 4 Pin configuration

- ∎ 1 Input
- 4 Output
- 2, 3, 5 Ground







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### 6 Characteristics

Temperature range for specification
Input terminating impedance
Output terminating impedance

 $\begin{array}{ll} T_{\rm SPEC} & = -40 \ ^{\circ}{\rm C} \ ... \ +85 \ ^{\circ}{\rm C} \\ Z_{\rm IN} & = 50 \ \Omega \ {\rm with \ par. \ 10 \ nH^{1)}} \\ Z_{\rm OUT} & = 50 \ \Omega \ {\rm with \ ser. \ 1.2 \ nH^{1)}} \end{array}$ 

Characteristics					$\begin{array}{c} {\rm min.} \\ {\rm for} \ {\rm T}_{_{\rm SPEC}} \end{array}$	<b>typ.</b> @+25 °C	max. for T <sub>SPEC</sub>	
Center frequency				f <sub>c</sub>		2442		MHz
Maximum insertion attenuation								
Bluetooth		2401.5 2480.5	MHz	$\alpha_{max}^{3)}$	_	1.5	2.0	dB
WLAN Channel 1	@f	2403.1 2420.9	MHz	$lpha_{WLAN,max}^{(2)}$	—	1.9	2.7	dB
WLAN Channel 2	@f	2408.1 2425.9	MHz	$lpha_{WLAN,max}^{(2)}$	—	1.7	2.2	dB
WLAN Channel 3-11	@f	2413.1 2470.9	MHz	$lpha_{_{WLAN,max}}^{~~2)}$	_	1.4	2.0	dB
WLAN Channel 12	@f	2458.1 2475.9	MHz	$lpha_{WLAN,max}^{(2)}$	_	1.6	2.2	dB
WLAN Channel 13	@f	2463.1 2480.9	MHz	$lpha_{_{WLAN,max}}^{~~2)}$	_	1.8	2.7	dB
Maximum VSWR				VSWR <sub>max</sub>				
@ input port		2403.1 2475.9	MHz		_	1.6	2.3	
		2463.1 2480.9	MHz		—	1.8	2.5	
@ output port		2403.1 2475.9	MHz		_	1.6	2.3	
		2463.1 2480.9	MHz		_	1.8	2.3	
Minimum attenuation								
		100 1805	MHz	$\alpha_{_{min}}$	32	37	—	dB
		1805 2170	MHz	$\alpha_{_{min}}$	33	38	—	dB
		2300 2360	MHz	$\alpha_{_{min}}$	35	40	—	dB
		2360 2365	MHz	$\alpha_{min}^{4)}$	38	42	—	dB
		2365 2370	MHz	$\alpha_{min}^{4)}$	40	43	—	dB
		2370 2375	MHz	$\alpha_{min}^{4)}$	35	45		dB
		2375 2380	MHz	$\alpha_{min}^{4)}$	15	42	_	dB
		2500 2505	MHz	$\alpha_{min}^{4)}$	26 <sup>5)</sup>	62	_	dB
		2500 2505	MHz	$\alpha_{min}^{4)}$	43 <sup>6)</sup>	62	_	dB
		2505 2570	MHz	$\alpha_{_{min}}$		52	_	dB
		2570 2620	MHz	α <sub>min</sub>	42	47	—	dB
		2620 2690	MHz	α <sub>min</sub>	40	47	_	dB
		4800 5850	MHz	$\alpha_{_{min}}$	20	28	_	dB

<sup>1)</sup> See Sec. Matching circuit (p. 5).

<sup>2)</sup> Average over each WLAN channel with band width of 17.8 MHz.

<sup>3)</sup> Averaged values over whole pass band due to frequency hopping in Bluetooth mode.

<sup>4)</sup> Averaged values of linear S-parameter over any 5MHz.

<sup>5)</sup> Valid for temperature  $T_{\text{SPEC}} = -40 \text{ °C...}+25 \text{ °C.}$ 

<sup>6)</sup> Valid for temperature  $T_{\text{SPEC}} = +25 \text{ °C...}+85 \text{ °C.}$ 



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### 7 Maximum ratings

Storage temperature	<i>T</i> <sub>STG</sub> = -40 °C +85 °C	
DC voltage	$V_{\rm DC} = 0 V$	
Input power	P <sub>IN</sub>	
@ input port: 2403.1 2480.9 MHz	25 dBm	Continuous wave for 5000 h @ 85 °C. Source and load impedance 50Ω.
@ output port: 2403.1 2480.9 MHz	22 dBm	Continuous wave for 5000 h @ 85 °C. Source and load impedance 50Ω.



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### 8 Transmission coefficient

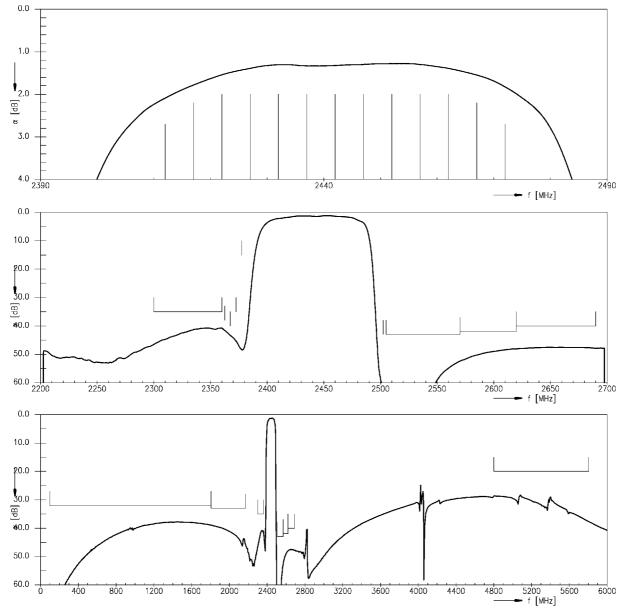


Figure 4: Attenuation.



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### 9 Reflection coefficients

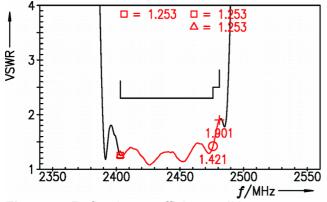
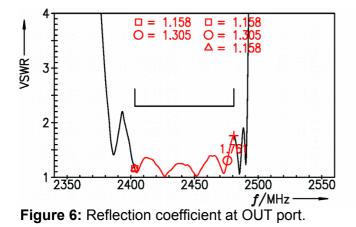
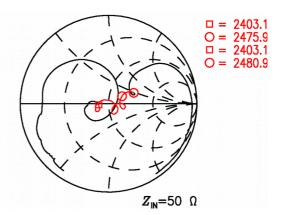
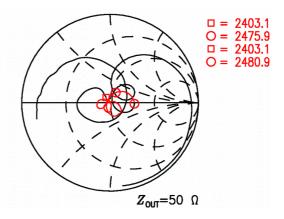


Figure 5: Reflection coefficient at IN port.







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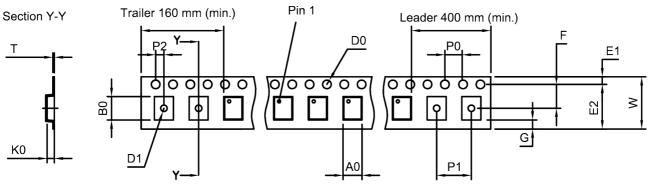
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### 10 Packing material

### 10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A <sub>0</sub>	1.27±0.05 mm
B₀	1.57±0.05 mm
D <sub>0</sub>	1.5+0.1/-0 mm
D <sub>1</sub>	0.5±0.1 mm
E1	1.75±0.1 mm

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K <sub>0</sub>	0.62±0.05 mm
P <sub>0</sub>	4.0±0.1 mm

<b>P</b> <sub>1</sub>	4.0±0.1 mm
P <sub>2</sub>	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

 Table 1: Tape dimensions.

### 10.2 Reel with diameter of 180 mm

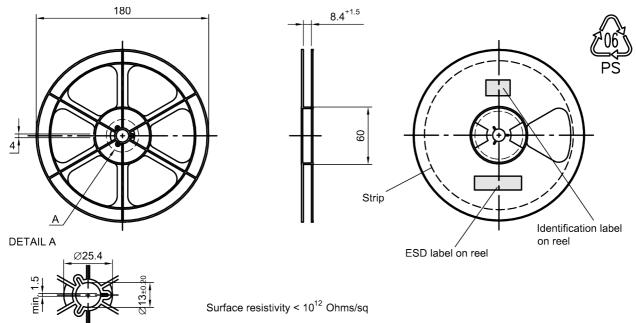


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.



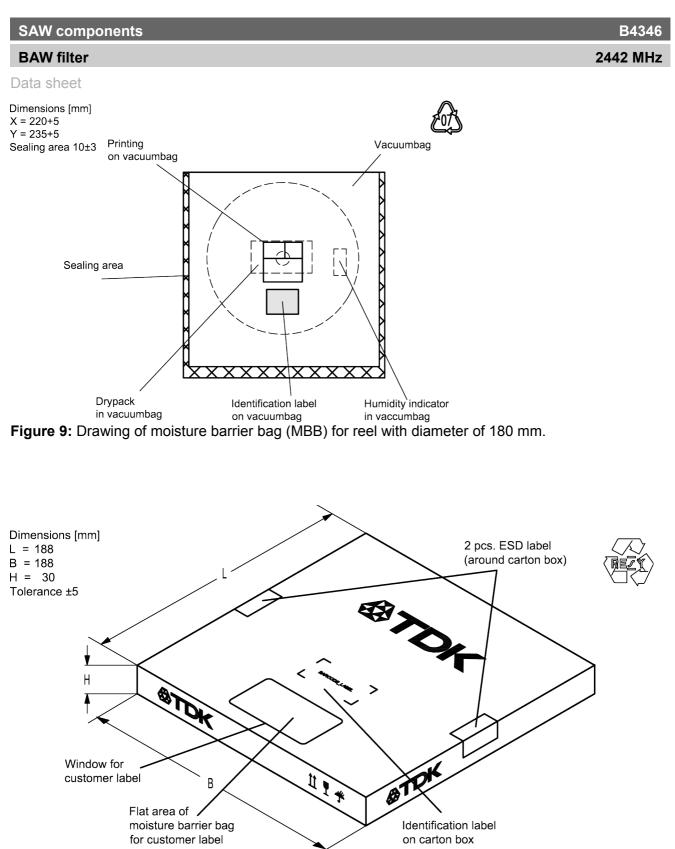


Figure 10: Drawing of folding box for reel with diameter of 180 mm.

### 11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:



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The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit mai	•	, B3xxxxB <u>1234</u> xxxx,
Example of decoding type number marking on device <b>16J</b> <b>1</b> x 32 <sup>2</sup> + <b>6</b> x 32 <sup>1</sup> + <b>18 (=J)</b> x 32 <sup>0</sup> The BASE32 code for product type B4346 is 47T.	=> =	in decimal code. 1234 1234
■ Lot number:		
The last 5 digits of the lot number, are encoded based on a special BASE47 code into a 3	e.g. digit marking.	, 12345,
Example of decoding lot number marking on device 5UY 5 x 47 <sup>2</sup> + 27 (=U) x 47 <sup>1</sup> + 31 (=Y) x 47 <sup>0</sup>	=> =	in decimal code. 12345 12345

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	К	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	A	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number			
		1	
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

**Table 2:** Lists for encoding and decoding of marking.



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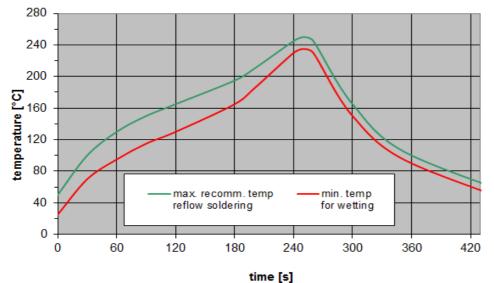
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### 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	_
peak temperature T <sub>peak</sub>	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 11:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

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### 13 Annotations

### 13.1 Matching coils

See TDK inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>.

### 13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

### **13.3 Scattering parameters (S-parameters)**

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

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#### 14 Cautions and warnings

### 14.1 Display of ordering codes for EPCOS products

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#### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

### 14.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

### 14.4 Package information

### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

#### **Projection method**

Unless otherwise specified first-angle projection is applied.

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